

Exhibit 1
cont wherein said step of forming a slurry includes adding sodium aluminate to said heated water.

REMARKS

This is a full and timely response to the non-final Official Action mailed November 30, 2000. Reexamination and reconsideration in light of the above amendments and the following remarks are courteously requested.


By the foregoing amendment, claim 22 has been amended. Additionally, claim 23 has been canceled. Thus, claims 12 to 14, and 16 to 27 are currently pending for the Examiner's consideration.

A full response to the rejections set forth in Paper No. 16 is included in the attached Supplemental Appeal Brief.

For the reasons set forth in the Brief, all the claims now pending in the present application are believed to be clearly patentable over the prior art of record. Accordingly, favorable reconsideration of the newly-presented claims in light of the above remarks is courteously solicited.

Respectfully submitted,

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Appendix
Amendments to the Claims

22. (amended) A polishing process which comprises the steps of:

forming a slurry containing abrasive boehmite particles by dipping particles of aluminum in heated water; and

planarizing at least one film formed on a substrate by employing a chemical-mechanical polishing process using said slurry,

wherein said step of forming a slurry includes adding sodium aluminate to said heated water.